

AD9618—SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS¹

Supply Voltages ($\pm V_S$)	± 7 V
Common Mode Input Voltage	$\pm V_S$
Differential Input Voltage	3 V
Continuous Output Current ²	70 mA
Operating Temperature Ranges	
AD9618JN/JR	0 to +70°C
AD9618AQ/BQ/SQ/TQ	-40°C to +85°C
AD9618SQ/TQ	-55°C to +125°C

Storage Temperature

AD9618JN/JR	-65°C to +125°C
AD9618AQ/BQ/SQ/TQ	-65°C to +150°C
Junction Temperature ³	
AD9618JN/JR	150°C
AD9618AQ/BQ/SQ/TQ	175°C
Lead Soldering Temperature (10 Seconds)	+300°C

DC ELECTRICAL CHARACTERISTICS

(unless otherwise noted, $A_V = +10$; $\pm V_S = \pm 5$ V; $R_F = 1000 \Omega$; $R_{LOAD} = 100 \Omega$)

Parameter	Conditions	Temp	Test Level	AD9618JN/JR			AD9618AQ/SQ			AD9618BQ/TQ			Units
				Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Input Offset Voltage ^{4, 5}		+25°C	I	-1.1	+0.5	+2.2	-1.1	+0.5	+2.2	0.0	+0.5	+1.1	mV
Input Offset Voltage TC ⁵		Full	IV	-4	+3	+25	-4	+3	+25	-4	+3	+25	μ V/°C
Input Bias Current ⁵													
Inverting		+25°C	I	-45	0	+45	-45	0	+45	-20	0	+20	μ A
Noninverting		+25°C	I	-25	+5	+35	-25	+5	+35	-13	+5	+18	μ A
Input Bias Current TC ⁵													
Noninverting		Full	IV	-50	+30	+125	-50	+30	+125	-50	+30	+125	nA/°C
Inverting		Full	IV	-50	+40	+130	-50	+40	+130	-50	+40	+130	nA/°C
Input Resistance													
Noninverting		+25°C	V		75			75			75		k Ω
Input Capacitance													
Noninverting		+25°C	V		1.5			1.5			1.5		pF
Common Mode Input Range ⁶	$T = T_{max}$	←	II	± 1.0	± 1.2		± 1.0	± 1.2		± 1.0	± 1.2		V
	$T = T_{min}$ to +25°C	←	II	± 1.4	± 1.5		± 1.4	± 1.5		± 1.4	± 1.5		V
Common Mode Rejection Ratio ⁷	$T = T_{max}$	←	II	44	48		44	48		44	48		dB
	$T = +25^\circ\text{C}$	←	II	48	52		48	52		48	52		dB
	$T = T_{min}$	←	II	50	54		50	54		50	54		dB
Power Supply Rejection Ratio	$\Delta V_S = \pm 5\%$	Full	II	50	60		50	60		50	60		dB
Open Loop Gain													
T_O	At dc	+25°C	V		3			3			3		M Ω
Nonlinearity	At dc	+25°C	V		5			5			5		ppm
Output Voltage Range		+25°C	II	± 3.3	± 3.7		± 3.3	± 3.7		± 3.3	± 3.7		V
Output Impedance	At dc	+25°C	V		0.08			0.08			0.08		Ω
Output Current (50 Ω Load)	$T = +25^\circ\text{C}$ to T_{max}	←	II	60			60			60			mA
	$T = T_{min}$	←	II	50			50			50			mA

AC ELECTRICAL CHARACTERISTICS

(unless otherwise noted, $A_V = +10$; $\pm V_S = \pm 5$ V; $R_F = 1 \text{ k}\Omega$; $R_{LOAD} = 100 \Omega$)

Parameter	Conditions	Temp	Test Level	AD9618JN/JR			AD9618AQ/SQ			AD9618BQ/TQ			Units
				Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
FREQUENCY DOMAIN													
Bandwidth (-3 dB)													
Small Signal	$V_{OUT} \leq 2$ V p-p	Full	II	130	160		130	160		130	160		MHz
Large Signal	$V_{OUT} \leq 5$ V p-p	Full	IV		150		120	150		120	150		MHz
Bandwidth Variation vs. A_V	$A_V = -1$ to ± 40	+25°C	V		35			35			35		MHz
Amplitude of Peaking (<50 MHz)	$T = T_{min}$ to +25°C	←	II		0			0	0.4		0	0.4	dB
	$T = T_{max}$	←	II		0			0	0.7		0	0.7	dB
Amplitude of Peaking (>50 MHz)	$T = T_{min}$ to +25°C	←	II		0			0	0.6		0	0.6	dB
	$T = T_{max}$	←	II		0			0	1.2		0	1.2	dB
Amplitude of Roll-Off (<75 MHz)		Full	II		0.5			0.5	1.2		0.5	1.2	dB
Phase Nonlinearity	dc to 75 MHz	+25°C	V		0.5			0.5			0.5		Degree
2nd Harmonic Distortion	2 V p-p; 4.3 MHz	Full	IV		-83	-75		-83	-75		-83	-75	dBc
	2 V p-p; 20 MHz	Full	IV		-63	-55		-63	-55		-63	-55	dBc
	2 V p-p; 60 MHz	Full	II		-51	-43		-51	-43		-51	-43	dBc
3rd Harmonic Distortion	2 V p-p; 4.3 MHz	Full	IV		-85	-77		-85	-77		-85	-77	dBc
	2 V p-p; 20 MHz	Full	IV		-70	-62		-70	-62		-70	-62	dBc
	2 V p-p; 60 MHz	Full	II		-62	-54		-62	-54		-62	-54	dBc
Input Noise Voltage	10 MHz	+25°C	V		1.2			1.2			1.2		nV/ $\sqrt{\text{Hz}}$
Inverting Input Noise Current	10 MHz	+25°C	V		24			24			24		pA/ $\sqrt{\text{Hz}}$

Parameter	Conditions	Temp	Test Level	AD9618JN/JR			AD9618AQ/SQ			AD9618BQ/TQ			Units			
				Min	Typ	Max	Min	Typ	Max	Min	Typ	Max				
Average Equivalent Integrated Input Noise Voltage	0.1 to 200 MHz	+25°C	V	38			38			38			μV, rms			
TIME DOMAIN																
Slew Rate	V _{OUT} = 4 V Step	Full	IV	1800			1400 1800			1400 1800			V/μs			
Rise/Fall Time	V _{OUT} = 2 V Step V _{OUT} = 5 V Step	T = +25°C to T = T _{min}	Full	IV	←	IV	2.2			2.2 2.6			2.2 2.6			ns
							2.3			2.3 2.8			2.3 2.8			ns
							2.3			2.3 3.1			2.3 3.1			ns
Overshoot	V _{OUT} = 2 V Step	Full	IV	2			2 10			2 10			%			
Settling Time	V _{OUT} = 2 V Step V _{OUT} = 2 V Step V _{OUT} = 4 V Step V _{OUT} = 4 V Step	Full	IV	9			9 15			9 15			ns			
To 0.1%				14			14 23			14 23			ns			
To 0.02%				10			10 16			10 16			ns			
To 0.02%				16			16 24			16 24			ns			
2×Overdrive Recovery to ±2 mV of Final Value	V _{IN} = 0.6 V Step	+25°C	V	50			50			50			ns			
Propagation Delay		+25°C	V	2			2			2			ns			
Differential Gain ⁸		Full	V	0.01			0.01			0.01			%			
Differential Phase ⁸		Full	V	0.02			0.02			0.02			Degree			
POWER SUPPLY REQUIREMENTS																
Quiescent Current		Full	II	31 43			31 43			31 43			mA			
+I _S				31 43			31 43			31 43						
-I _S		Full	II	31 43			31 43			31 43			mA			

NOTES

¹Absolute maximum ratings are limiting values to be applied individually and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.

²Output is short circuit protected to ground, but not to supplies. Continuous short circuit to ground may affect device reliability.

³Typical thermal impedances (part soldered onto board):

Mini-DIP: θ_{JA} = 140°C/W; θ_{JC} = 30°C/W.

Side Brazed/Cerdip: θ_{JA} = 110°C/W; θ_{JC} = 20°C/W.

SOIC Package: θ_{JA} = 150°C/W; θ_{JC} = 30°C/W.

⁴Measured with respect to the inverting input.

⁵Typical is defined as the mean of the distribution.

⁶Measured in voltage follower configuration.

⁷Measured with V_{IN} = ±0.25 V.

⁸Frequency = 4.3 MHz; R_L = 150 Ω; A_V = +10.

Specifications subject to change without notice.

EXPLANATION OF TEST LEVELS

Test Level

I - 100% production tested.

II - 100% production tested at +25°C and sample tested at specified temperatures. AC testing of J grade devices done on sample basis.

III - Sample tested only.

IV - Parameter is guaranteed by design and characterization testing.

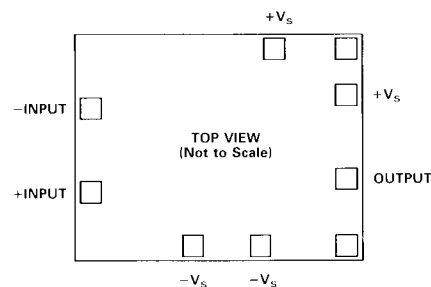
V - Parameter is a typical value only.

VI - All devices are 100% production tested at +25°C. 100% production tested at temperature extremes for extended temperature devices; sample tested at temperature extremes for commercial/industrial devices.

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
AD9618JN	0 to +70°C	Plastic DIP	N-8
AD9618JR	0 to +70°C	SOIC	R-8
AD9618AQ	-40°C to +85°C	Cerdip	Q-8
AD9618BQ	-40°C to +85°C	Cerdip	Q-8
AD9618SQ	-55°C to +125°C	Cerdip	Q-8
AD9618TQ	-55°C to +125°C	Cerdip	Q-8

DIE CONNECTIONS



DIE SIZE = 53 × 67 × 15 mils

AD9618

THEORY OF OPERATION

The AD9618 has been designed to combine the key attributes of traditional "low frequency" precision amplifiers with exceptional high frequency characteristics that are independent of closed-loop gain. Previous "high frequency" closed-loop amplifiers have low open loop gain relative to precision amplifiers. This results in relatively poor dc nonlinearity and precision, as well as excessive high frequency distortion due to open loop gain roll-off.

Operational amplifiers use two basic types of feedback correction, each with advantages and disadvantages. Voltage feedback topologies exhibit an essentially constant gain bandwidth product. This forces the closed-loop bandwidth to vary inversely with closed-loop gain. Moreover, this type design typically slew rate limits in a way that causes the large signal bandwidth to be much lower than its small signal characteristics.

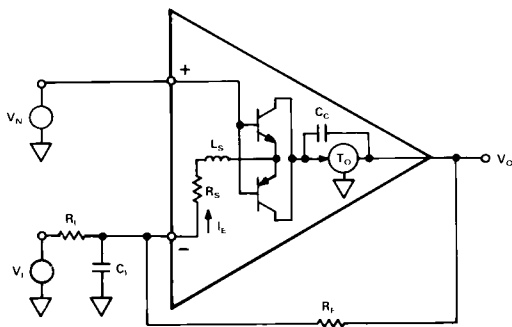
A newer approach is to use current feedback to realize better dynamic performance. This architecture provides two key attributes over voltage feedback configurations: (1) avoids slew rate limiting and therefore large signal bandwidth can approach small signal performance; and (2) low bandwidth variation versus gain settings, due to the inherently low open loop inverting input resistance (R_S).

The AD9618 uses a new current feedback topology that overcomes these limitations and combines the positive attributes of both current feedback and voltage feedback designs. These devices achieve excellent high frequency dynamics (slew, BW and distortion) along with excellent low frequency linearity and good dc precision.

DC GAIN CHARACTERISTICS

A simplified equivalent schematic is shown below. When operating the device in the inverting mode, the input signal error current (I_E) is amplified by the open loop transimpedance gain (T_O). The output signal generated is equal to $T_O \times I_E$. Negative feedback is applied through R_F such that the device operates at a gain (G) equal to $-R_F/R_I$.

Noninverting operation is similar, with the input signal applied to the high impedance buffer (noninverting) input. As before,



Equivalent Circuit

an output (buffer) error current (I_E) is generated at the low impedance inverting input. The signal generated at the output is fed back to the inverting input such that the external gain is $(1 + R_F/R_I)$. The feedback mechanics are identical to the voltage feedback topology when exact equations are used.

The major difference lies in the front end architecture. A voltage feedback amplifier has symmetrical high resistance (buffered) inputs. A current feedback amplifier has a high noninverting

resistance (buffered) input and a low inverting (buffer output) input resistance. The feedback mechanics can be easily developed using current feedback and transresistance open loop gain $T(s)$ to describe the I/O relationship. (See typical specification chart.)

DC closed-loop gain for the AD9618 can be calculated using the following equations:

$$G = \frac{V_O}{V_I} \approx \frac{-R_F/R_I}{1 + 1/LG} \quad \text{inverting} \quad (1)$$

$$G = \frac{V_O}{V_N} \approx \frac{1 + R_F/R_I}{1 + 1/LG} \quad \text{noninverting} \quad (2)$$

$$\text{where: } \frac{1}{LG} \approx \frac{R_S(R_F + R_S||R_I)}{T(s)(R_S||R_I)} \quad (3)$$

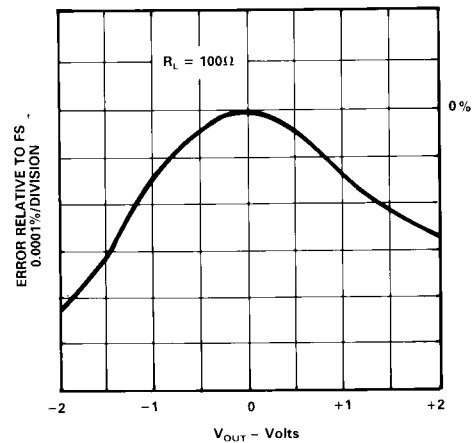
Because the noninverting input buffer is not ideal, input resistance R_S (at dc) is gain dependent and is typically higher for noninverting operation than for inverting operation. R_S will approach the same value ($\approx 9 \Omega$) for both at input frequencies above 50 MHz. Below the open loop corner frequency, the non-inverting R_S can be approximated as:

$$R_S(\text{noninverting}) \approx 9 + \frac{T(s)}{A_O} = 9 + \frac{T_O}{A_O} \quad \text{dc} \quad (4)$$

where: $A_O = \text{Open Loop Voltage Gain} \approx G \times 350$
 Inverting R_S below the open loop corner frequency can be approximated as:

$$R_S(\text{inverting}) \approx 9 + \frac{T(s)}{A_O} = 9 + \frac{T_O}{A_O} \quad \text{dc} \quad (5)$$

where: $A_O = 140,000$



DC Nonlinearity vs. V_{OUT}

The AD9618 approaches this condition. With $T_O = 3 \times 10^6 \Omega$ and $R_S = 32 \Omega$ (dc), a gain error of 0.04% typically results for $G = -1$ and 0.11% for $G = -100$. Moreover, the architecture linearizes the open loop gain over its operating voltage range and temperature resulting in >16 bits of linearity.

AC GAIN CHARACTERISTICS

Closed-loop bandwidth at high frequencies is determined primarily by the roll-off of T(s). But circuit layout is critical to minimize external parasitics which can degrade performance by causing premature peaking and/or reduced bandwidth.

The inverting and noninverting dynamic characteristics are similar. When driving the noninverting input, the inverting input capacitance (C_I) will cause the noninverting closed-loop bandwidth to be higher than the inverting bandwidth for gains less than five (5). In the remaining cases, inverting and noninverting responses are nearly identical.

For best overall dynamic performance, the value of the feedback resistor (R_F) should be 1000 Ω. Although bandwidth reduces as closed-loop gain increases, the change is relatively small due to low equivalent series input impedance, Z_S. (See typical performance charts.) The simplified equations governing the device's dynamic performance are shown below.

Closed-Loop Gain vs. Frequency:
(noninverting operation)

$$\frac{V_O}{V_S} \approx \frac{1 + \frac{R_F}{R_I}}{s\tau \left(1 + \frac{R_S}{R_I}\right) + 1} \quad (6)$$

where: $\tau = R_F \times C_C = 1.0 \text{ ns}$ ($R_F = 1 \text{ k}\Omega$)

$$\text{Slew Rate} \approx \frac{\Delta V_O}{R_F K C_C} \times e^{-\tau/R_F K C_C} \quad (7)$$

where: $K = 1 + \frac{R_S}{R_I}$

Increasing Bandwidth at Low Gains

By reducing R_F, wider bandwidth and faster pulse response can be attained beyond the specified values, although increased overshoot, settling time, and possible ac peaking may result. As a rule of thumb, overshoot and bandwidth will increase by 1% and 8%, respectively, for a 5% reduction in R_F at gains of ±10.

Equations 6 and 7 are simplified and do not accurately model the second order (open loop) frequency response term which is the primary contributor to overshoot, peaking, and nonlinear bandwidth expansion. (See Open Loop Bode Plots.) The user should exercise caution when selecting R_F values much lower than 1000 Ω. Note that a feedback resistor must be used in all situations.

Increasing Bandwidth at High Gains

Closed-loop bandwidth can be extended at high closed-loop gain by reducing R_F. Bandwidth reduction is a result of the feedback current being split between R_S and R_I. As the gain increases (for a given R_F), more feedback current is shunted through R_I, which reduces closed-loop bandwidth (see Equation 6). To maintain specified BW, the following equations can be used to approximate R_F and R_I for any gain from = +5/-1 to ±40.

$$R_F = 1100 \pm 8 G \quad (8)$$

(+ for inverting and - for noninverting)

$$R_I \approx \frac{1100 - 10 G}{G - 1} \quad (\text{noninverting}) \quad (9)$$

$$R_I \approx \frac{1100 + 10 G}{G} \quad (\text{inverting}) \quad (10)$$

G = Closed-Loop Gain.

Bandwidth Reduction

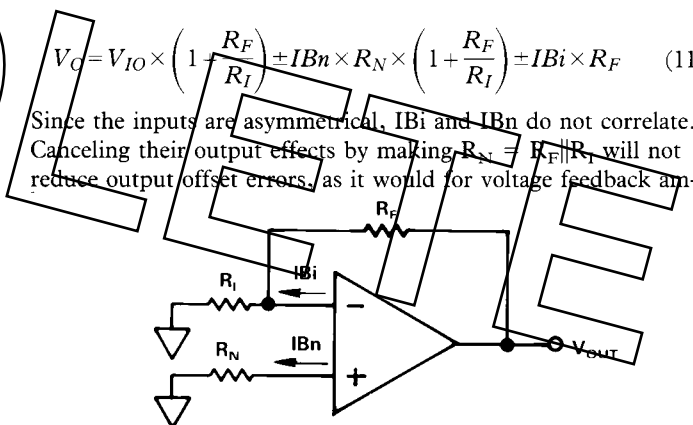
The closed-loop bandwidth can be reduced by increasing R_F. Equations 6 and 7 can be used to determine the closed-loop bandwidth for any value R_F. Do not connect a feedback capacitor across R_F, as this will degrade dynamic performance and possibly induce oscillation.

DC Precision and Noise

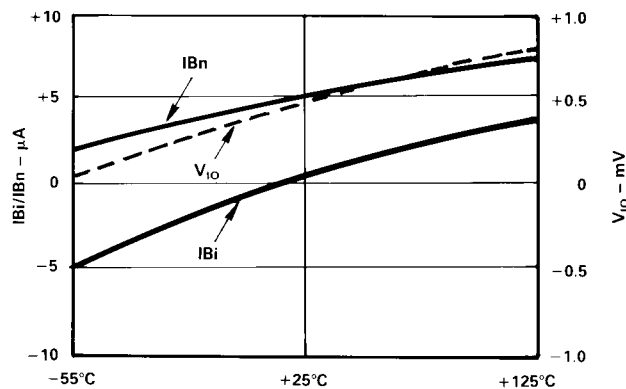
Output offset voltage results from both input bias currents and input offset voltage. These input errors are multiplied by the noise gain term (1 + R_F/R_I) and algebraically summed at the output as shown below.

$$V_O = V_{IO} \times \left(1 + \frac{R_F}{R_I}\right) \pm IB_n \times R_N \times \left(1 + \frac{R_F}{R_I}\right) \pm IB_i \times R_F \quad (11)$$

Since the inputs are asymmetrical, IB_i and IB_n do not correlate. Canceling their output effects by making R_N = R_F || R_I will not reduce output offset errors, as it would for voltage feedback amplifiers.



Output Offset Voltage



DC Accuracy

plifiers. Typically, IB_n is 5 μA and V_{IO} is +0.5 mV (1 sigma = 0.3 mV), which means that the dc output error can be reduced by making R_N ≈ 100 Ω. Note that the offset drift will not change significantly because the IB_n TC is relatively small. (See specification table.)

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The effective noise at the output of the amplifier can be determined by taking the root sum of the squares of Equation 11 and applying the spectral noise values found in the typical graph section. This applies to noise from the op amp only. Note that both the noise figure and equivalent input offset voltage improve as the closed-loop gain is increased (by keeping R_F fixed and reducing R_I with $R_N = 0 \Omega$).

Typical circuits for inverting and noninverting applications are shown in Figures 1 and 2.

Closed-loop gain for noninverting configurations is determined by the value of R_I according to the equation:

$$G = 1 + \frac{R_F}{R_I} \quad (12)$$

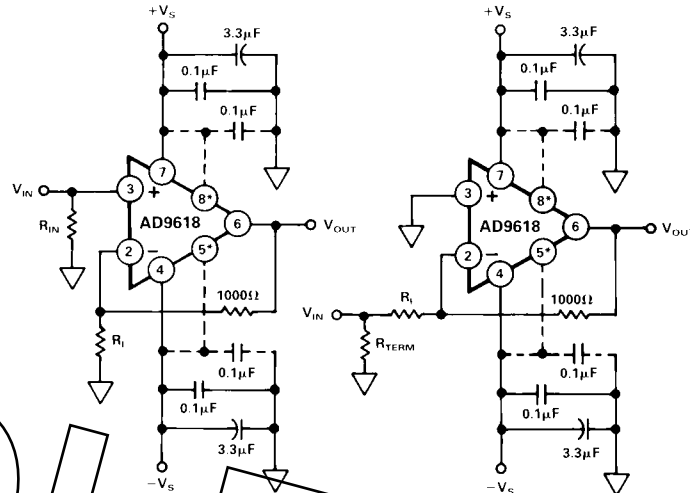


Figure 1. Noninverting Operation
Figure 2. Inverting Operation

To preserve the amplifier's full bandwidth, the noninverting input should be driven from a low impedance source.

A recommended circuit for an inverting amplification is shown in Figure 2.

Closed-loop gain for inverting configurations is determined by the value of R_I per the following equation:

$$G = -\frac{R_F}{R_I} \quad (13)$$

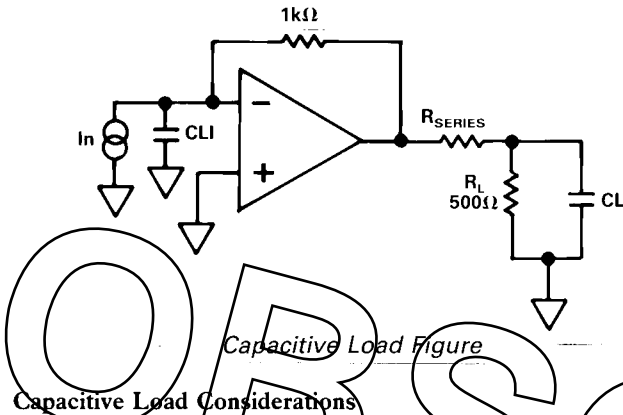
LAYOUT CONSIDERATIONS

As with all high performance amplifiers, printed circuit layout is critical in obtaining optimum results with the AD9618. The ground plane in the area of the amplifier should cover as much of the component side of the board as possible. Each power supply trace should be decoupled close to the package with at least a 3.3 μF tantalum and a low inductance, 0.1 μF ceramic capacitor.

All lead lengths for input, output, and the feedback resistor should be kept as short as possible. All gain setting resistors should be chosen for low values of parasitic capacitance and inductance, i.e., microwave resistors and/or carbon resistors.

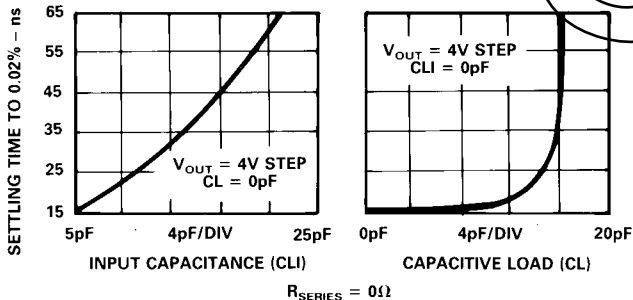
Stripline techniques should be used for lead lengths in excess of one inch. Sockets should be avoided if possible because of their stray inductance and capacitance. If sockets are necessary, individual pin sockets such as AMP p/n 6-330808-3 should be used. These contribute far less stray reactance than molded socket assemblies.

An evaluation board is available from Analog Devices for a nominal charge.



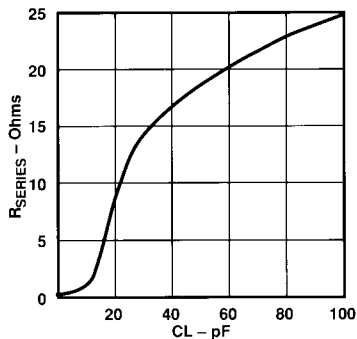
Capacitive Load Considerations

Due to the low inverting input resistance (R_S) and output buffer design, the AD9618 can directly handle input and/or output load capacitances of up to 10 pF. See the chart below.



Input/Output Capacitance Comparisons

A small series resistor can be used at the output of the amplifier and outside of the feedback loop to facilitate driving larger capacitive loads or for obtaining faster settling time. For capacitive loads above 10 pF, R_{SERIES} should be considered.

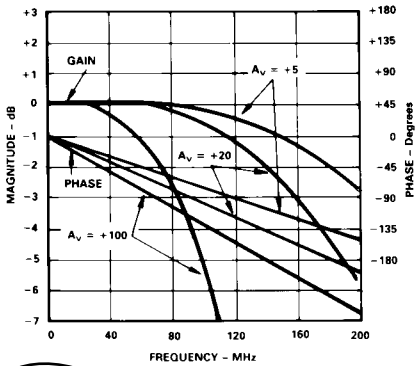


Recommended R_{SERIES} vs. CL

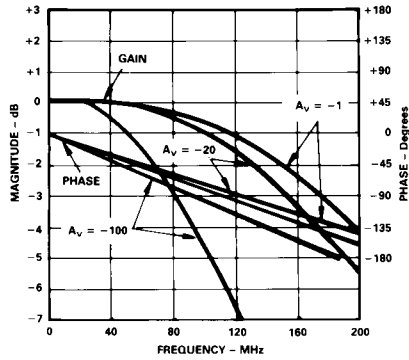
APPLYING THE AD9618

The superior frequency and time domain specifications of the AD9618 make it an obvious choice for driving flash converters and buffering the outputs of high speed DACs. Its outstanding distortion and noise performance make it well suited as a driver for analog-to-digital converters (ADCs) with resolutions as high as 16 bits.

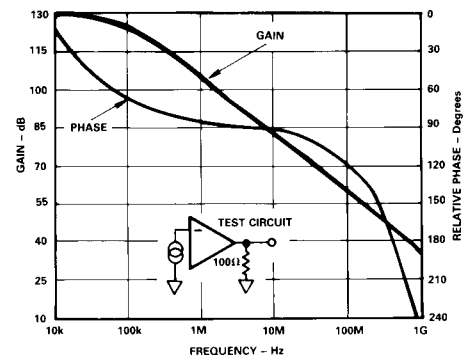
Typical Performance ($A_v = +10$; $\pm V_S = \pm 5V$; $R_F = 1\text{ k}\Omega$, unless otherwise noted)



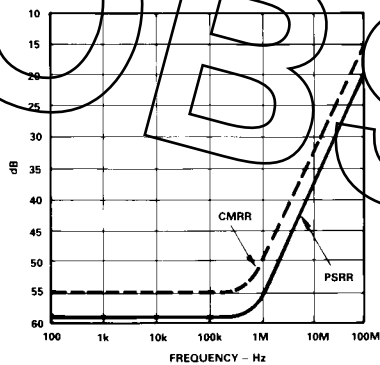
Noninverting Frequency Response



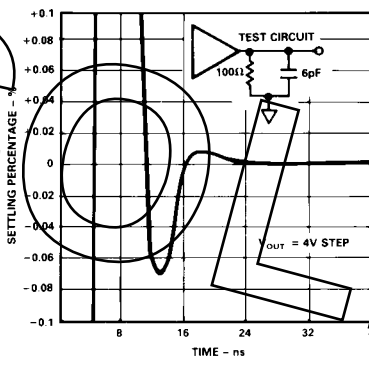
Inverting Frequency Response



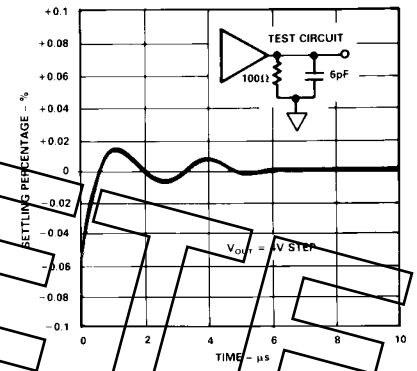
Open Loop Transimpedance Gain [T(s) Relative to $1\ \Omega$]



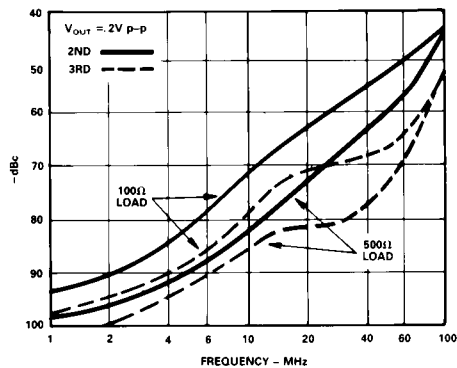
CMRR and PSRR



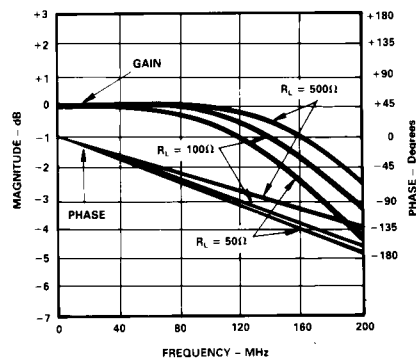
Settling Time



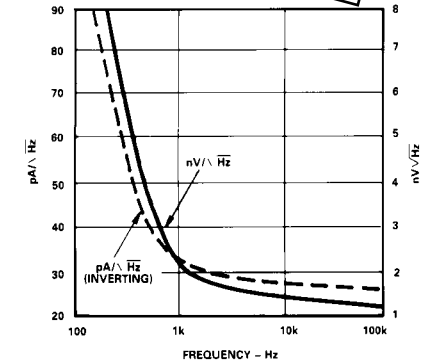
Long Term Settling Time



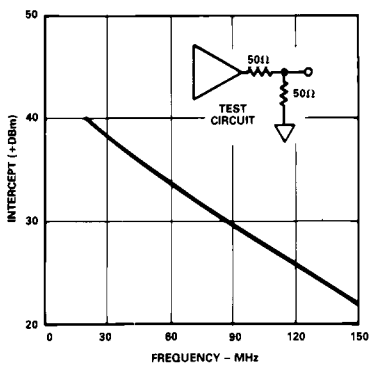
Harmonic Distortion



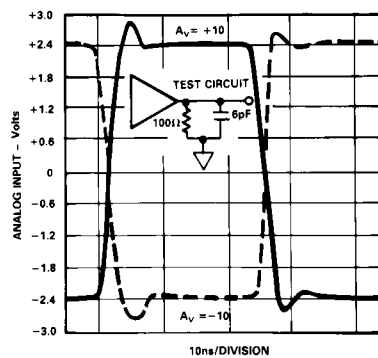
Frequency Response vs. R_{LOAD}



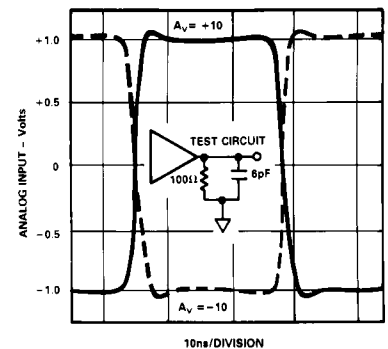
Equivalent Input Noise



Intermodulation Distortion (IMD)



Large Signal Pulse Response

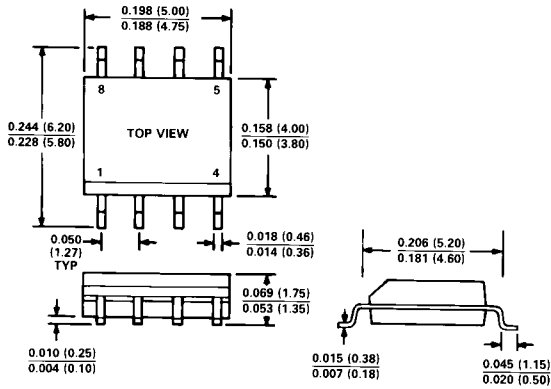


Small Signal Pulse Response

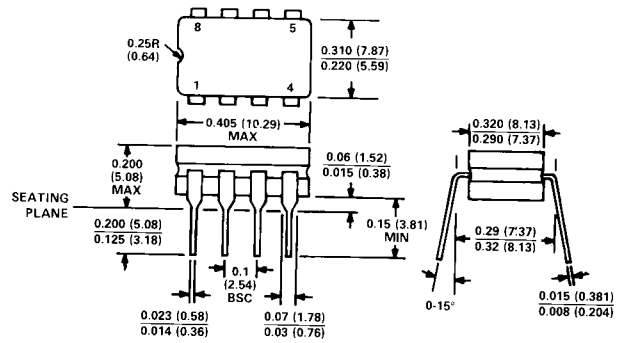
OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

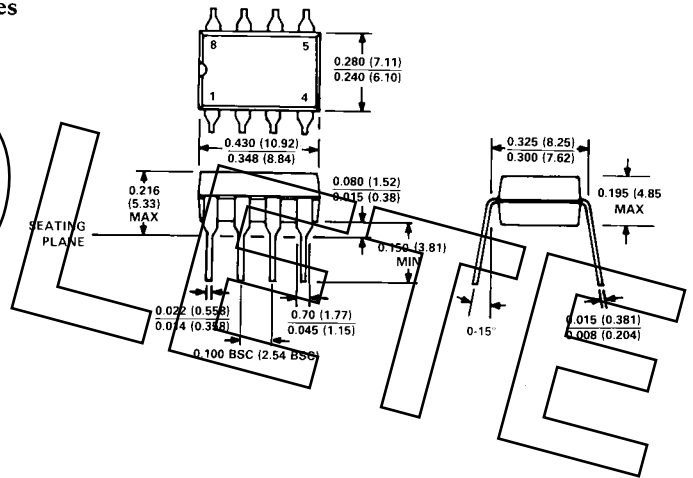
Suffix JR



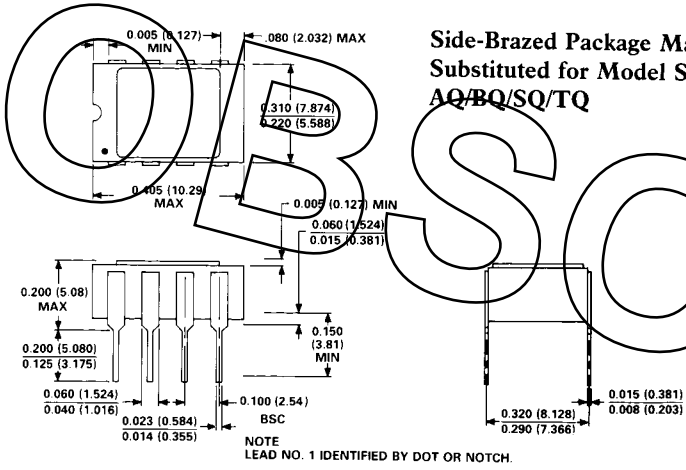
Suffixes AQ/BQ/SQ/TQ/883B



Suffix JN



Side-Braced Package May Be Substituted for Model Suffixes AQ/BQ/SQ/TQ



Suffixes SZ/TZ

